

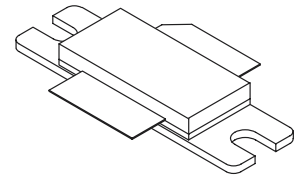
The RF MOSFET Line  
**RF Power Field Effect Transistors**  
N-Channel Enhancement-Mode Lateral MOSFETs

Designed for PCN and PCS base station applications with frequencies from 1.9 to 2.0 GHz. Suitable for CDMA, TDMA, GSM and multicarrier amplifier applications.

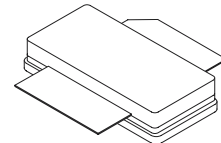
- Typical CDMA Performance: 1960 MHz, 26 Volts  
IS-97 CDMA Pilot, Sync, Paging, Traffic Codes 8 Through 13  
Output Power — 7.5 Watts  
Power Gain — 12.5 dB  
Adjacent Channel Power —  
885 kHz: -47 dBc @ 30 kHz BW  
1.25 MHz: -55 dBc @ 12.5 kHz BW  
2.25 MHz: -55 dBc @ 1 MHz BW
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 10:1 VSWR, @ 26 Vdc, 1.93 GHz, 60 Watts CW Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Available in Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 Inch Reel.

**MRF19060**  
**MRF19060R3**  
**MRF19060SR3**

**1990 MHz, 60 W, 26 V**  
**LATERAL N-CHANNEL**  
**RF POWER MOSFETs**



**CASE 465-06, STYLE 1**  
**NI-780**  
**MRF19060R3**



**CASE 465A-06, STYLE 1**  
**NI-780S**  
**MRF19060SR3**

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	Vdc
Gate-Source Voltage	$V_{GS}$	-0.5, +15	Vdc
Total Device Dissipation @ $T_C \geq 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	180 1.03	Watts $\text{W}/^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-65 to +150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	200	$^\circ\text{C}$

**ESD PROTECTION CHARACTERISTICS**

Test Conditions	Class
Human Body Model	1 (Minimum)
Machine Model	M3 (Minimum)

**THERMAL CHARACTERISTICS**

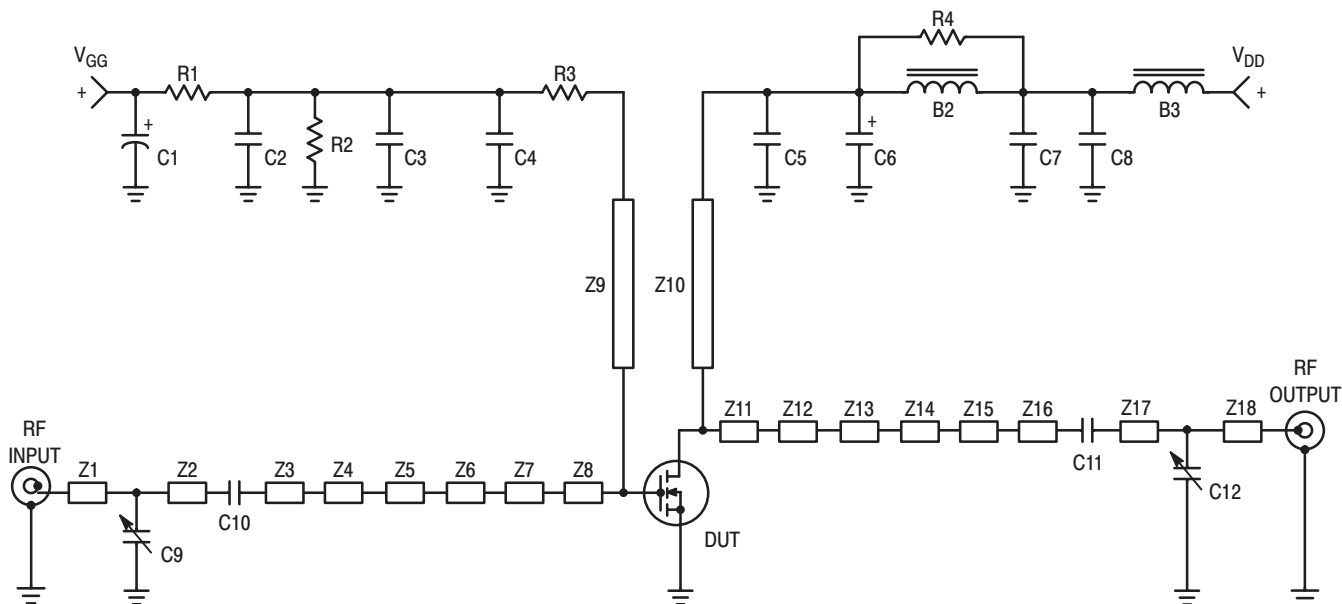
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.97	$^\circ\text{C}/\text{W}$

**NOTE - CAUTION** - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Drain–Source Breakdown Voltage ( $V_{GS} = 0\text{ Vdc}$ , $I_D = 10\ \mu\text{Adc}$ )	$V_{(BR)DSS}$	65	—	—	Vdc
Zero Gate Voltage Drain Current ( $V_{DS} = 26\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ )	$I_{DSS}$	—	—	6	$\mu\text{Adc}$
Gate–Source Leakage Current ( $V_{GS} = 5\text{ Vdc}$ , $V_{DS} = 0\text{ Vdc}$ )	$I_{GSS}$	—	—	1	$\mu\text{Adc}$
<b>ON CHARACTERISTICS</b>					
Forward Transconductance ( $V_{DS} = 10\text{ Vdc}$ , $I_D = 2\text{ Adc}$ )	$g_{fs}$	—	4.7	—	S
Gate Threshold Voltage ( $V_{DS} = 10\text{ Vdc}$ , $I_D = 300\ \mu\text{Adc}$ )	$V_{GS(th)}$	2	—	4	V
Gate Quiescent Voltage ( $V_{DS} = 26\text{ Vdc}$ , $I_D = 500\text{ mAdc}$ )	$V_{GS(Q)}$	2.5	3.9	4.5	V
Drain–Source On–Voltage ( $V_{GS} = 10\text{ Vdc}$ , $I_D = 2\text{ Adc}$ )	$V_{DS(on)}$	—	0.27	—	V
<b>DYNAMIC CHARACTERISTICS</b>					
Reverse Transfer Capacitance (1) ( $V_{DS} = 26\text{ Vdc}$ , $V_{GS} = 0$ , $f = 1\text{ MHz}$ )	$C_{rss}$	—	2.7	—	pF
<b>FUNCTIONAL TESTS</b> (In Motorola Test Fixture, 50 ohm system)					
Two–Tone Common–Source Amplifier Power Gain ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 60\text{ W PEP}$ , $I_{DQ} = 500\text{ mA}$ , $f = 1930\text{ MHz}$ and $1990\text{ MHz}$ , Tone Spacing = 100 kHz)	$G_{ps}$	11	12.5	—	dB
Two–Tone Drain Efficiency ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 60\text{ W PEP}$ , $I_{DQ} = 500\text{ mA}$ , $f = 1930\text{ MHz}$ and $1990\text{ MHz}$ , Tone Spacing = 100 kHz)	$\eta$	33	36	—	%
3rd Order Intermodulation Distortion ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 60\text{ W PEP}$ , $I_{DQ} = 500\text{ mA}$ , $f = 1930\text{ MHz}$ and $1990\text{ MHz}$ , Tone Spacing = 100 kHz)	IMD	—	–31	–28	dBc
Input Return Loss ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 60\text{ W PEP}$ , $I_{DQ} = 500\text{ mA}$ , $f = 1930\text{ MHz}$ and $1990\text{ MHz}$ , Tone Spacing = 100 kHz)	IRL	—	–12	—	dB
$P_{out}$ , 1 dB Compression Point ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 60\text{ W CW}$ , $f = 1990\text{ MHz}$ )	P1dB	—	60	—	W
Output Mismatch Stress ( $V_{DD} = 26\text{ Vdc}$ , $P_{out} = 60\text{ W CW}$ , $I_{DQ} = 500\text{ mA}$ , $f = 1930\text{ MHz}$ , VSWR = 10:1, All Phase Angles at Frequency of Tests)	$\Psi$	No Degradation In Output Power Before and After Test			

(1) Part is internally matched both on input and output.



B2 – B3	Ferrite Beads, Fair Rite, 2743019447	Z4	0.152" x 0.140" Microstrip
C1	10 $\mu$ F, 50 V Electrolytic Capacitor, Panasonic #ECEV1HV100R	Z5	0.090" x 0.102" Microstrip
C2, C7	1000 pF Chip Capacitors, B Case, ATC #100B102JCA500X	Z6	0.245" x 0.217" Microstrip
C3, C8	0.10 $\mu$ F Chip Capacitors, B Case, Kemet #CDR33BX104AKWS	Z7	0.090" x 0.737" Microstrip
C4	5.1 pF Chip Capacitor, B Case, ATC #100B5R1JCA500X	Z8	0.530" x 0.941" Microstrip
C5	6.2 pF Chip Capacitor, B Case, ATC #100B6R2JCA500X	Z9	1.010" x 0.050" Microstrip
C6	22 $\mu$ F, 35 V Tantalum Capacitor, SMT, Sprague	Z10	1.060" x 0.050" Microstrip
C9	0.8 pF – 8.0 pF Variable Capacitor, Johanson Gigatrim	Z11	0.446" x 1.137" Microstrip
C10, C11	10 pF Chip Capacitors, B Case, ATC #100B100JCA500X	Z12	0.152" x 0.567" Microstrip
C12	0.4 pF – 2.5 pF Variable Capacitor, Johanson Gigatrim	Z13	0.183" x 0.220" Microstrip
R1	1 k $\Omega$ , 1/4 W Fixed Film Chip Resistor, 0.08" x 0.13"	Z14	0.100" x 0.338" Microstrip
R2	560 k $\Omega$ , 1/4 W Fixed Film Chip Resistor, 0.08" x 0.13"	Z15	0.480" x 0.142" Microstrip
R3	15 $\Omega$ , 1/4 W Fixed Film Chip Resistor, 0.08" x 0.13"	Z16	0.140" x 0.080" Microstrip
R4	10 $\Omega$ , 1/4 W Fixed Film Chip Resistor, 0.08" x 0.13"	Z17	0.173" x 0.080" Microstrip
Z1	0.580" x 0.074" Microstrip	Z18	0.420" x 0.080" Microstrip
Z2	0.100" x 0.074" Microstrip	Board	0.030" Glass Teflon <sup>®</sup> Arlon GX-0300-55-22, 2 oz Cu
Z3	0.384" x 0.074" Microstrip		

Figure 1. MRF19060 Test Circuit Schematic

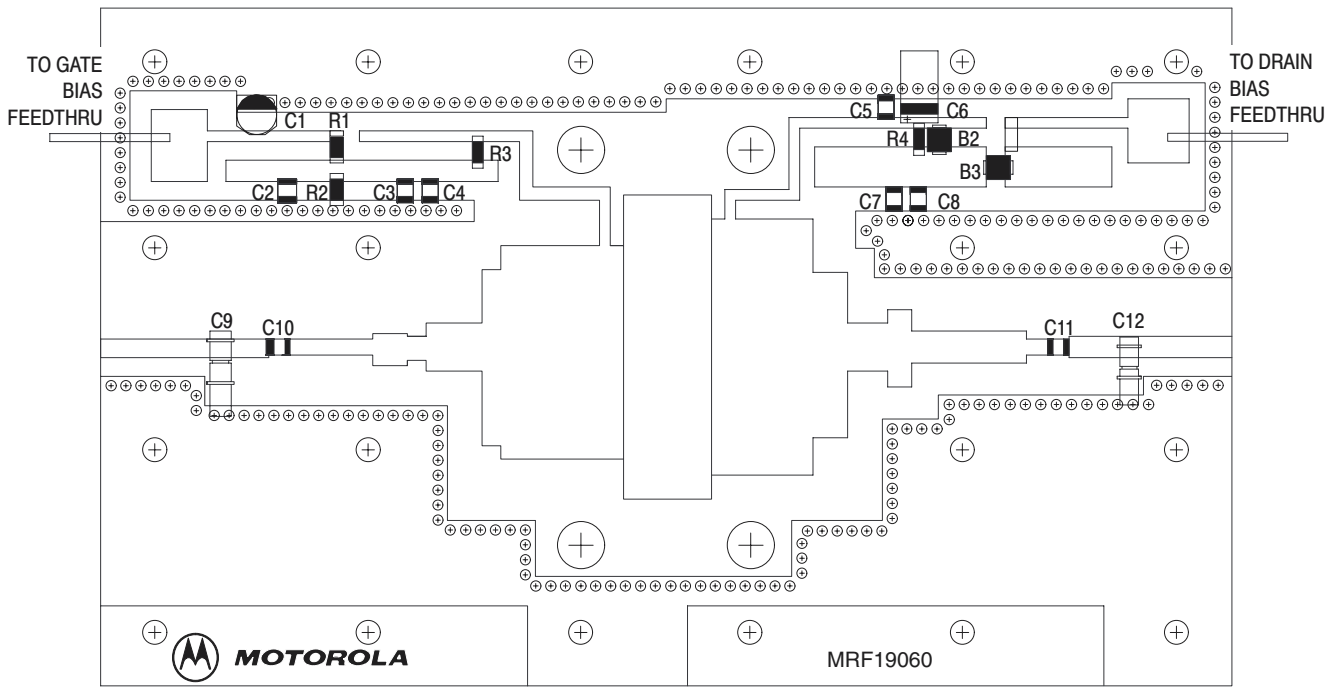
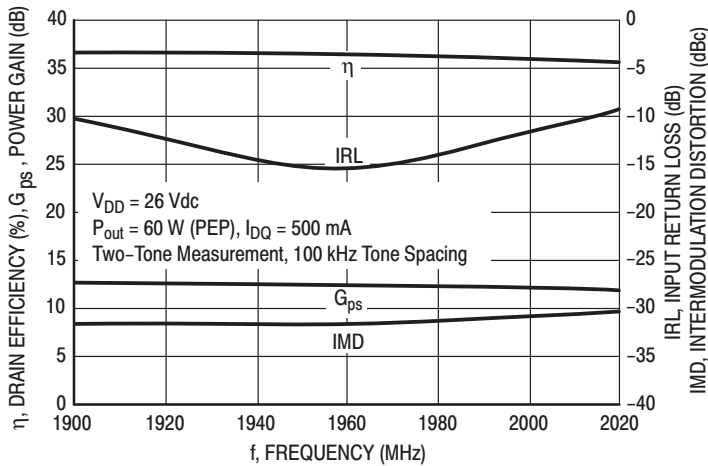
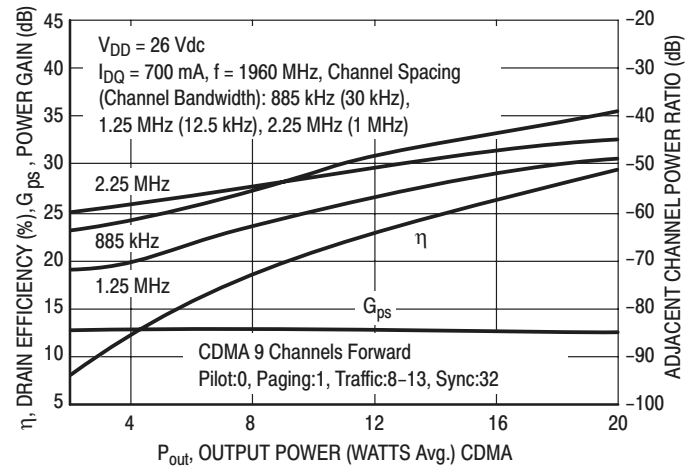


Figure 2. MRF19060 Test Circuit Component Layout

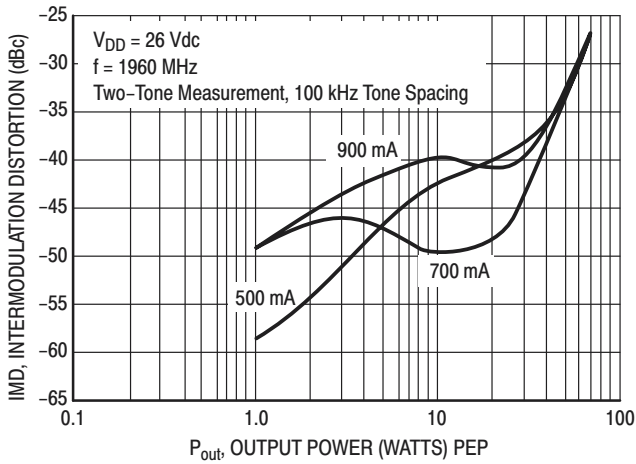
## TYPICAL CHARACTERISTICS



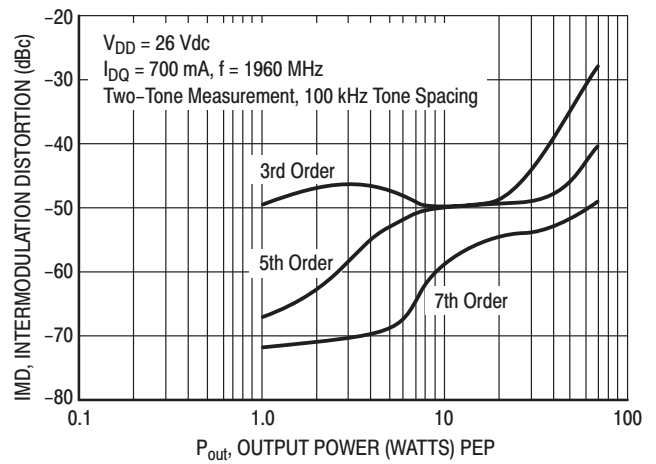
**Figure 3. Class AB Broadband Circuit Performance**



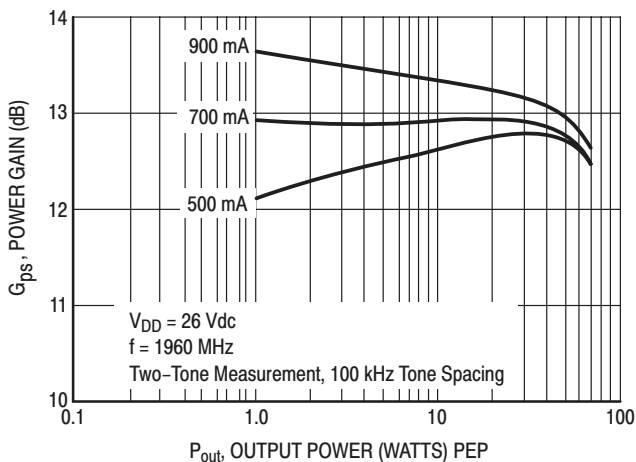
**Figure 4. CDMA ACPR, Power Gain and Drain Efficiency versus Output Power**



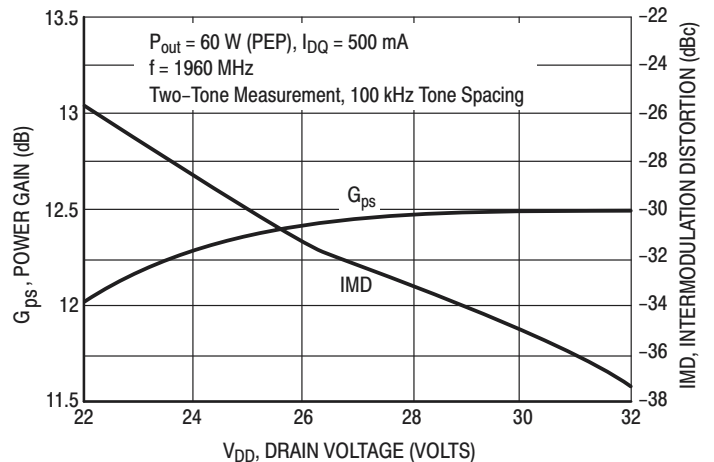
**Figure 5. Intermodulation Distortion versus Output Power**



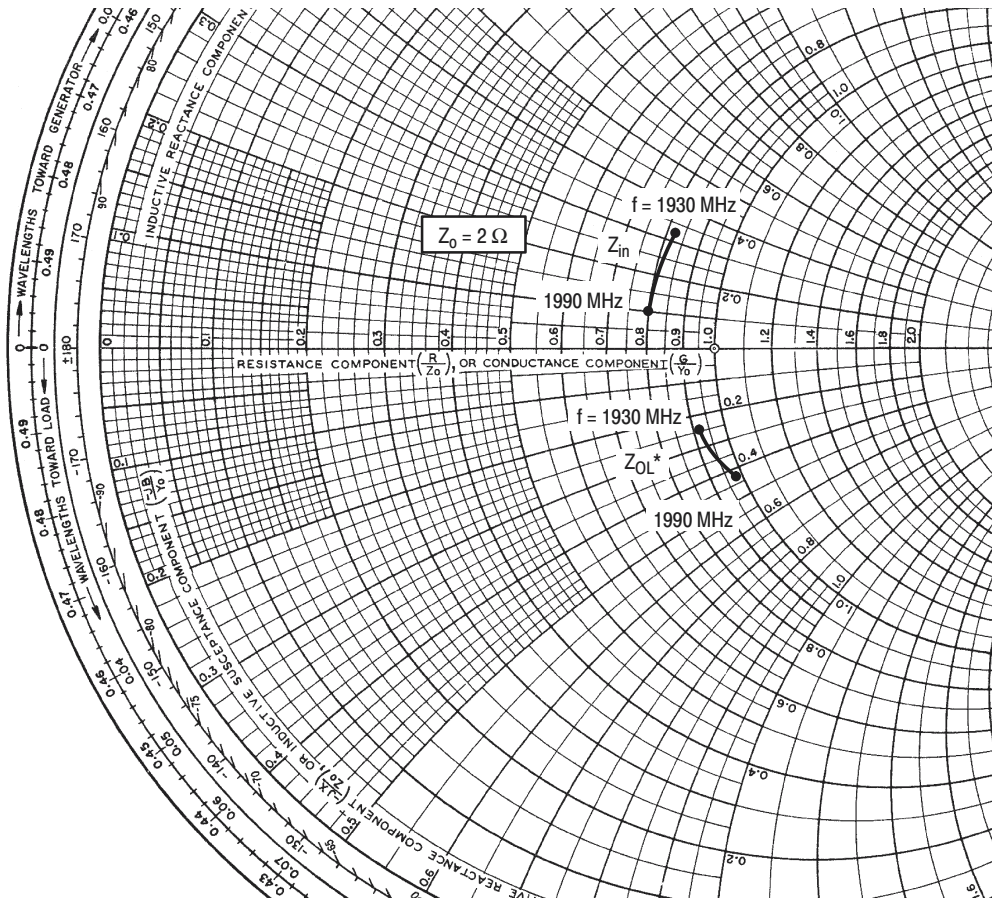
**Figure 6. Intermodulation Products versus Output Power**



**Figure 7. Power Gain versus Output Power**



**Figure 8. Power Gain and Intermodulation Distortion versus Supply Voltage**



$V_{DD} = 26 \text{ V}$ ,  $I_{DQ} = 500 \text{ mA}$ ,  $P_{out} = 60 \text{ W PEP}$

f MHz	$Z_{in}$ $\Omega$	$Z_{OL}^*$ $\Omega$
1930	$1.65 + j0.67$	$1.85 - j0.50$
1960	$1.64 + j0.45$	$1.89 - j0.74$
1990	$1.60 + j0.20$	$1.96 - j0.94$

$Z_{in}$  = Complex conjugate of source impedance.

$Z_{OL}^*$  = Complex conjugate of the optimum load impedance at a given output power, voltage, IMD, bias current and frequency.

Note:  $Z_{OL}^*$  was chosen based on tradeoffs between gain, output power, drain efficiency and intermodulation distortion.

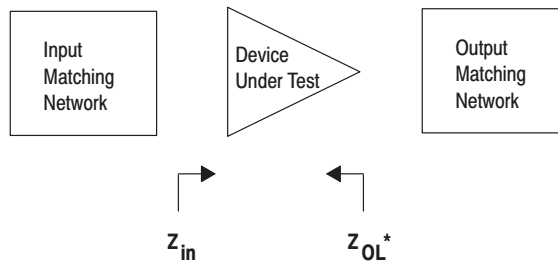
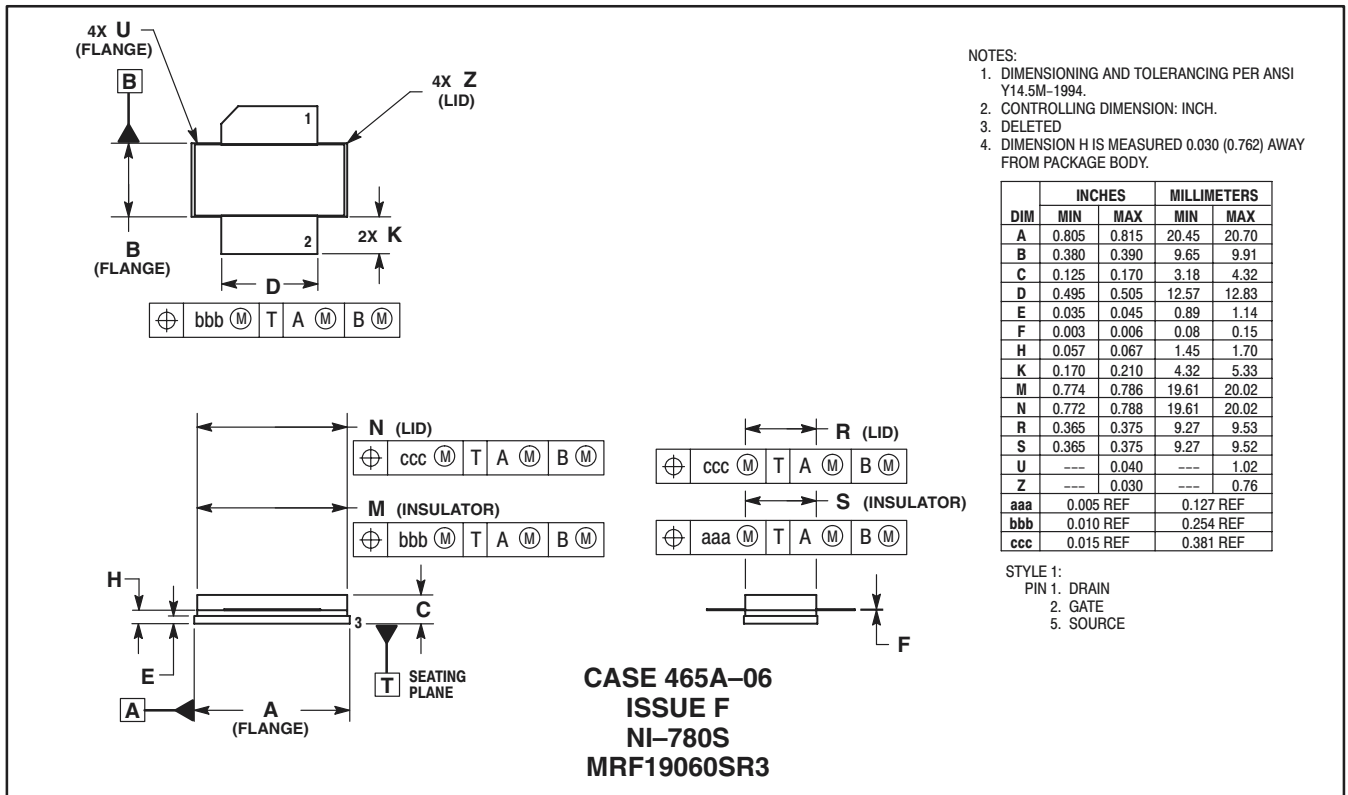
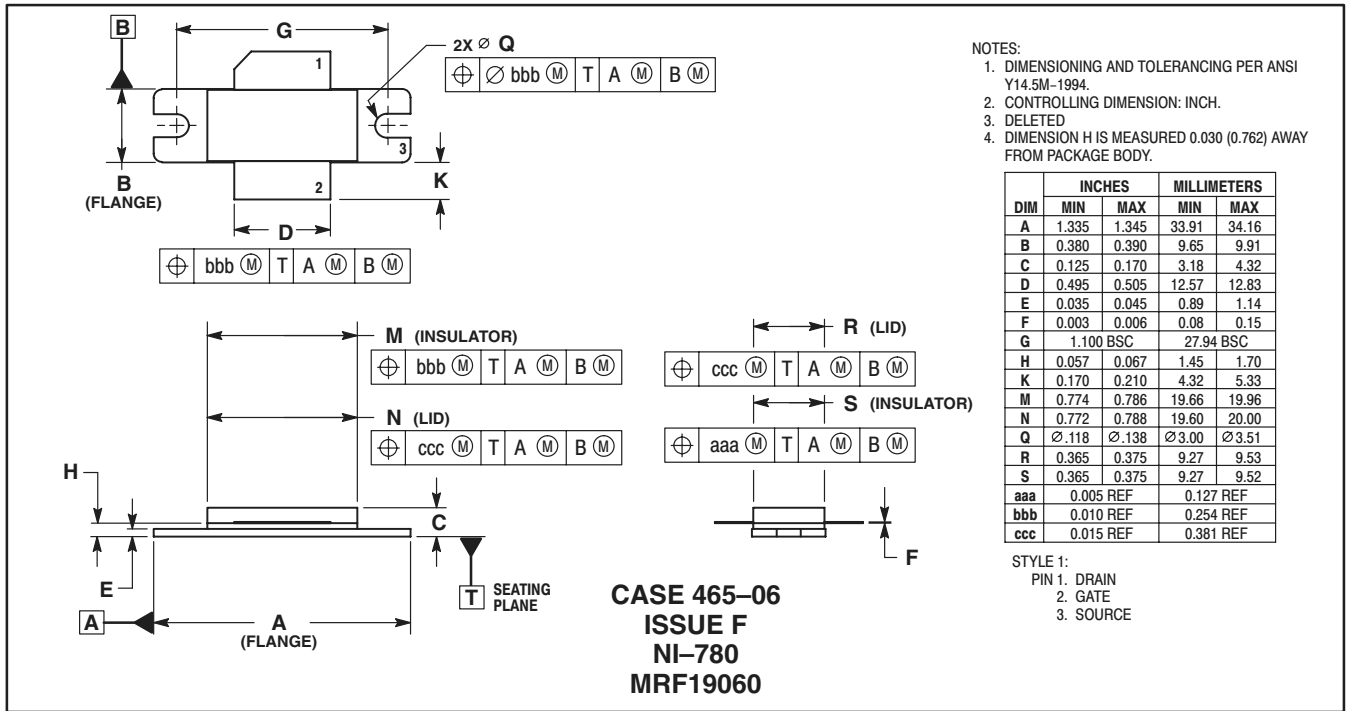



Figure 9. Series Equivalent Input and Output Impedance

## PACKAGE DIMENSIONS



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